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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/797,003	03/11/2004	Akiji Shibata	503.43552X00	3868	
20457	20457 7590 08/07/2006			EXAMINER	
	I, TERRY, STOUT &	CHAMBLIS	CHAMBLISS, ALONZO		
1300 NORTH SEVENTEENTH STREET SUITE 1800			ART UNIT	PAPER NUMBER	
ARLINGTON	VA 22209-3873		2814		

DATE MAILED: 08/07/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

	<u> </u>				
		Application No.	Applicant(s)		
•		10/797,003	SHIBATA ET AL.		
	Office Action Summary	Examiner	Art Unit		
·		Alonzo Chambliss	2814		
Period fo	The MAILING DATE of this communication app or Reply	ears on the cover sheet with the c	orrespondence address		
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).					
Status					
· —	1) Responsive to communication(s) filed on <u>13 February 2006</u> . 2a) This action is FINAL . 2b) This action is non-final.				
Dispositi	on of Claims		•		
4) Claim(s) 1-4 is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration. 5) Claim(s) is/are allowed. 6) Claim(s) 1-4 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or election requirement. Application Papers 9) The specification is objected to by the Examiner. 10) The drawing(s) filed on 2/13/06 is/are: a) accepted or b) objected to by the Examiner. Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a). Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d). 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.					
Priority under 35 U.S.C. § 119					
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 					
2) 🔲 Notico 3) 🔲 Inforn	e of References Cited (PTO-892) of Draftsperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) No(s)/Mail Date	4) Interview Summary (Paper No(s)/Mail Da 5) Notice of Informal Pa 6) Other:			

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DETAILED ACTION

1. The amendment filed on 12/21/05 has been fully considered and made of record in the instant application.

Drawings

- 2. The drawings were received on 2/13/06. These drawings are partially approved. The replacement sheet for Figs. 9 and 10 are approved but the replacement sheet for Figs. 11 and 12 are not approved since the "Prior Art" label is still missing above the figures.
- 3. Figures 11 and 12 should be designated by a legend such as --Prior Art--because only that which is old is illustrated. See MPEP § 608.02(g). Corrected drawings in compliance with 37 CFR 1.121(d) are required in reply to the Office action to avoid abandonment of the application. The replacement sheet(s) should be labeled "Replacement Sheet" in the page header (as per 37 CFR 1.84(c)) so as not to obstruct any portion of the drawing figures. If the changes are not accepted by the examiner, the applicant will be notified and informed of any required corrective action in the next Office action. The objection to the drawings will not be held in abeyance.

Response to Arguments

4. Applicant's arguments filed 12/21/05 have been fully considered but they are not persuasive.

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Claim Rejections - 35 USC § 102

5. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 6. Claims 1 and 2 are rejected under 35 U.S.C. 102(b) as being clearly anticipated by Weber (US 6,157,086).

With respect to Claims 1 and 2, Weber teaches a mold die comprising a first die 32 having a recess of a predetermined form and a second flat die 34. The first die to be disposed on a surface of a wiring board 14 (i.e. having a conductive pattern) by the mold compound 16, wherein the wiring board 14 has a plurality of openings 26 including a bonding opening (i.e. any opening in the substrate) and a semiconductor chip 12 mounted on the surface via an elastic material (i.e. solder bumps). The second die 34 is disposed on a back of the surface of the wiring board 14 on which the semiconductor chip 12 is mounted for sealing with an insulating resin 16 (i.e. by transfer mold process) a periphery of the semiconductor chip 12 and at least bonding opening 26 of the wiring board, wherein the second die 34 comprises a protrusion (i.e. about channel 38) disposed around an area overlapping the bonding opening 26 to be sealed with the insulating resin 16 (see col. 3 lines 20-67, col. 4 lines 1 –67, and col. 6 lines 15-20; Figs. 6-8).

7. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

8. Claims 3 and 4 are rejected under 35 U.S.C. 103(a) as being unpatentable over Weber (US 6,157,086) as applied to claims 1 and 2 above, and further in view of the Admitted Prior Art.

With respect to Claims 3 and 4, Weber fails to disclose wherein the wiring board has a conductive pattern electrically connected to an external electrode of the semiconductor chip in the bonding opening. However, the Admitted Prior Art discloses wherein the wiring board has a conductive pattern electrically connected to an external electrode of the semiconductor chip in the bonding opening (see Figs. 9 and 10). Thus, Weber and the Admitted Prior Art have substantially the same environment of a chip

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mounted on a substrate that is encapsulated in a mold. Therefore, one skilled in the art at the time of the invention would readily recognize placing the chip mounted on the substrate into the mold of Weber, since the chip mounted on the substrate when placed in the mold would facilitate in the bonding opening to be completely encapsulated prevent contamination of the bonding connection.

The prior art made of record and not relied upon is cited primarily to show the product of the instant invention.

Conclusion

9. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

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Any inquiry concerning the communication or earlier communications from the examiner should be directed to Alonzo Chambliss whose telephone number is (571) 1927.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the Group receptionist whose telephone number is (703) 308-7956

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system Status information for published applications may be obtained from either Private PMR or Public PMR. Status information for unpublished applications is available through Private PMR only. For more information about the PMR system see http://pair-dkect.uspto.gov. Should you have questions on access to the Private PMR system contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free) or EBC_Support@uspto.gov.

AC/July 25, 2006

Alonzo Chambliss

Primary Patent Examiner

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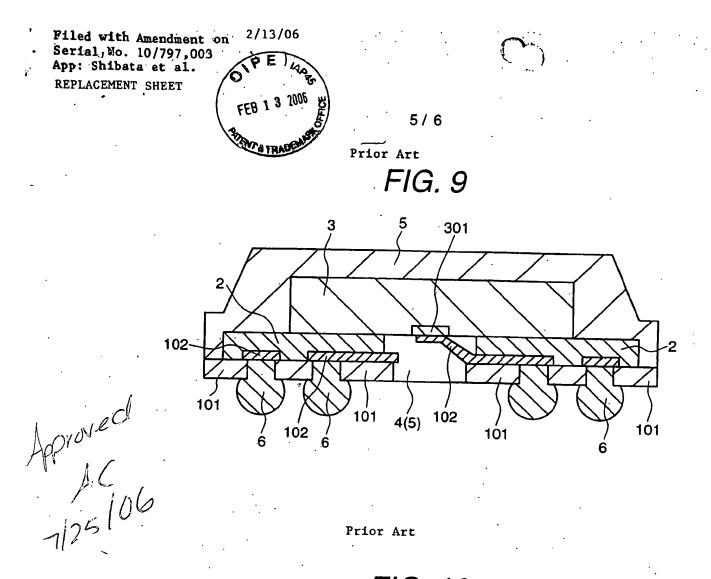
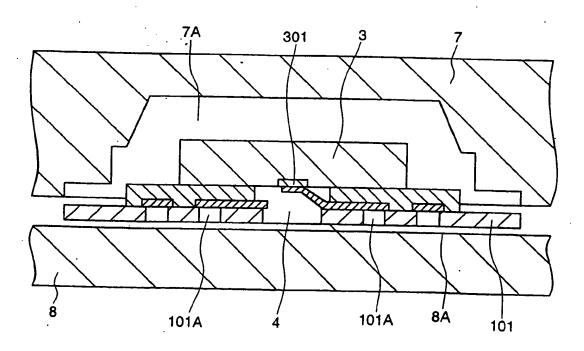


FIG. 10

Prior Art



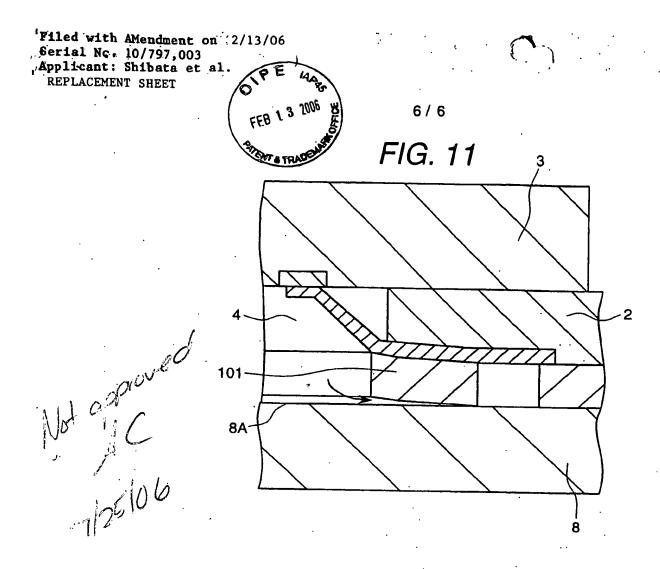


FIG. 12

